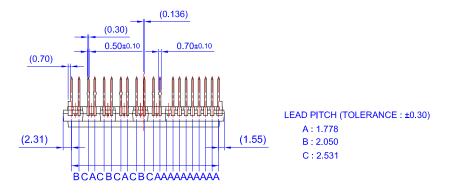
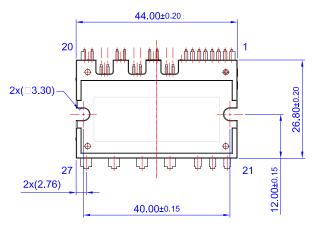
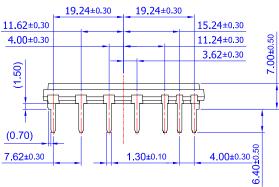


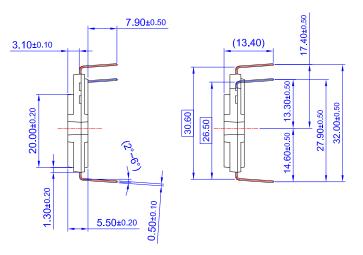
27LD MODULE PDD STD CASE MODCB ISSUE A

DATE 30 JAN 2023









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